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MIC915

Dual 135MHz Low-Power Op Amp

General Description

The MIC915 is a high-speed, unity-gain stable operational amplifier. It provides a gain-bandwidth product of 135MHz with a very low, 2.4mA supply current per op amp.

Supply voltage range is from $\pm 2.5V$ to $\pm 9V$, allowing the MIC915 to be used in low-voltage circuits or applications requiring large dynamic range.

The MIC915 is stable driving any capacitive load and achieves excellent PSRR, making it much easier to use than most conventional high-speed devices. Low supply voltage, low power consumption, and small packaging make the MIC915 ideal for portable equipment. The ability to drive capacitive loads also makes it possible to drive long coaxial cables.

Datasheets and support documentation are available on Micrel's web site at: www.micrel.com.

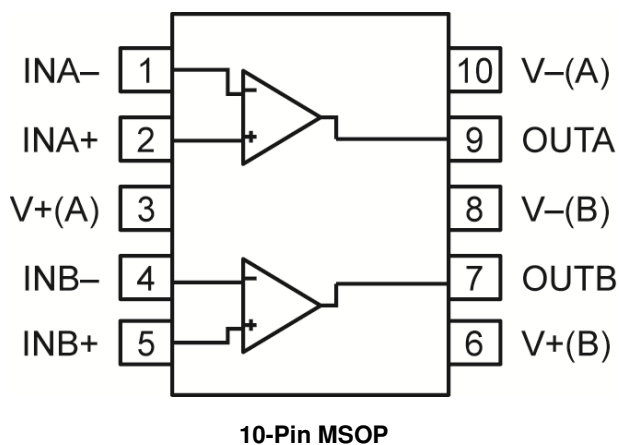
Features

- 135MHz gain bandwidth product
- 2.4mA supply current per op amp
- 10-pin MSOP package
- 270V/ μs slew rate
- Drives any capacitive load

Applications

- Video
- Imaging
- Ultrasound
- Portable equipment
- Line drivers

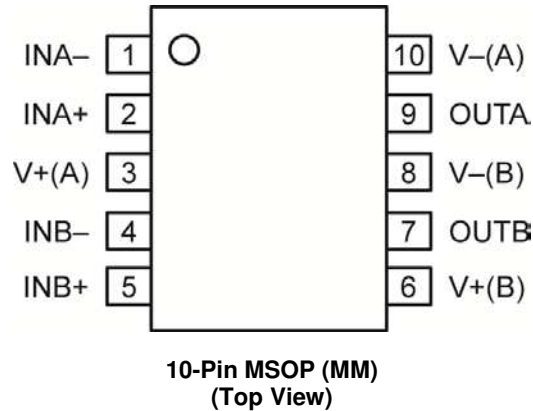
Functional Pinout



Ordering Information

Part Number	Junction Temperature Range	Package
MIC915YMM	-40°C to +85°C	10-Pin MSOP

Pin Configuration



Pin Description

Pin Number	Pin Name ⁽¹⁾	Pin Function
1	INA-	Inverting input of operational amplifier A.
2	INA+	Noninverting input of operational amplifier A.
3	V+(A)	Positive supply input for operational amplifier A. Connect a 10 μ F capacitor in parallel with a 0.1 μ F capacitor to ground.
4	INB-	Inverting input of operational amplifier B.
5	INB+	Noninverting input of operational amplifier B.
6	V+(B)	Positive supply input for operational amplifier B. Connect a 10 μ F capacitor in parallel with a 0.1 μ F capacitor to ground.
7	OUTB	Output of operational amplifier B.
8	V-(B)	Negative supply input for operational amplifier B. Connect a 10 μ F capacitor in parallel with a 0.1 μ F capacitor to ground.
9	OUTA	Output of operational amplifier A.
10	V-(A)	Negative supply input for operational amplifier A. Connect a 10 μ F capacitor in parallel with a 0.1 μ F capacitor to ground.

Note:

1. V- pins must be externally shorted together.

Absolute Maximum Ratings⁽²⁾

Supply Voltage ($V_{V+} - V_{V-}$)	+20V
Differential Input Voltage ($ V_{IN+} - V_{IN-} $)	8V ⁽⁴⁾
Input Common-Mode Range (V_{IN+}, V_{IN-})	V_{V+} to V_{V-}
Lead Temperature (soldering, 5s)	+260°C
Storage Temperature (T_S)	+150°C
ESD Rating ⁽⁵⁾	1.5kV

Operating Ratings⁽³⁾

Supply Voltage (V_S)	$\pm 2.5V$ to $\pm 9V$
Junction Temperature (T_J)	$-40^\circ C$ to $+85^\circ C$
Package Thermal Resistance	
10-Pin MSOP (θ_{JA})	+160°C/W

Electrical Characteristics ($\pm 5V$)

$V_{V+} = +5V$; $V_{V-} = -5V$, $V_{CM} = 0V$, $V_{OUT} = 0V$; $R_L = 10M\Omega$; $T_J = +25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +85^\circ C$, unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{OS}	Input Offset Voltage			1	15	mV
	Input Offset Voltage Temperature Coefficient			4		$\mu V/^\circ C$
I_B	Input Bias Current			3.5	5.5	μA
					9	
I_{OS}	Input Offset Current			0.05	3	μA
V_{CM}	Input Common-Mode Range	CMRR > 60dB	-3.25		+3.25	V
CMRR	Common-Mode Rejection Ratio	$-2.5V < V_{CM} < +2.5V$	70	90		dB
			60			
PSRR	Power Supply Rejection Ratio	$\pm 5V < V_S < \pm 9V$	74	81		dB
			70			
A_{VOL}	Large-Signal Voltage Gain	$R_L = 2k\Omega$, $V_{OUT} = \pm 2V$	60	71		dB
		$R_L = 200\Omega$, $V_{OUT} = \pm 2V$	60	71		
V_{OUT}	Maximum Output Voltage Swing	Positive, $R_L = 2k\Omega$	+3.3	3.5		V
			+3.0			
		Negative, $R_L = 2k\Omega$		-3.5	-3.3	
					-3.0	
		Positive, $R_L = 200\Omega$	+3.0	3.2		
			+2.75			
Negative, $R_L = 200\Omega$		-2.8	-2.45			
			-2.2			
GBW	Gain Bandwidth Product	$R_L = 1k\Omega$		125		MHz
BW	-3dB Bandwidth	$A_V = 1$, $R_L = 100\Omega$		192		MHz
SR	Slew Rate			230		V/ μs

Notes:

- Exceeding the absolute maximum ratings may damage the device.
- The device is not guaranteed to function outside its operating ratings.
- Exceeding the maximum differential input voltage will damage the input stage and degrade performance as input bias current is likely to increase.
- Devices are ESD sensitive. Handling precautions are recommended. Human body model, 1.5k Ω in series with 100pF.

Electrical Characteristics ($\pm 5V$) (Continued)

$V_{V+} = +5V$; $V_{V-} = -5V$, $V_{CM} = 0V$, $V_{OUT} = 0V$; $R_L = 10M\Omega$; $T_J = +25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +85^\circ C$, unless noted.

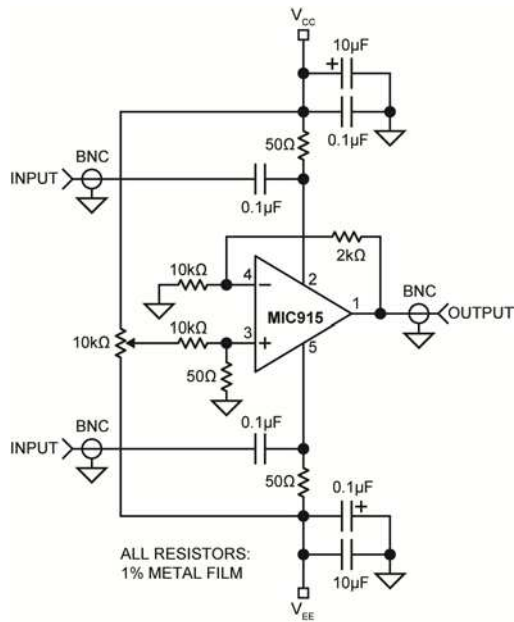
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
	Crosstalk	$f = 1MHz$		82		dB
I_{GND}	Short-Circuit Output Current	Source		72		mA
		Sink		25		
	Supply Current per Op Amp			2.4	3.5	
					4.1	

Electrical Characteristics ($\pm 9V$)

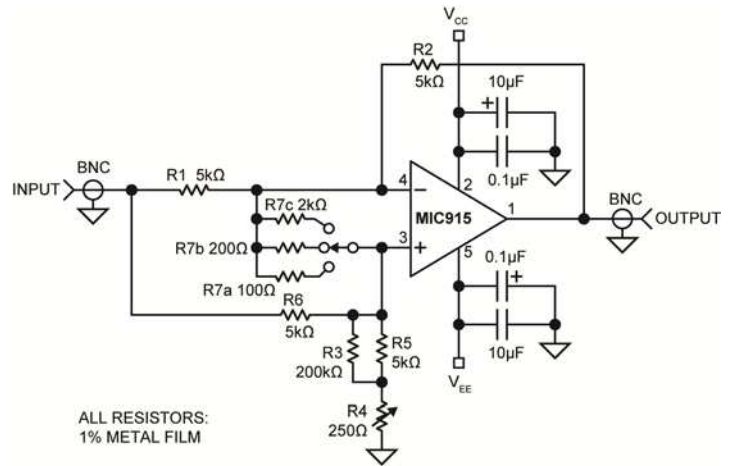
$V_{V+} = +9V$; $V_{V-} = -9V$, $V_{CM} = 0V$, $V_{OUT} = 0V$; $R_L = 10M\Omega$; $T_J = +25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +85^\circ C$, unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{OS}	Input Offset Voltage			1	15	mV
	Input Offset Voltage Temperature Coefficient			4		$\mu V/^\circ C$
I_B	Input Bias Current			3.5	5.5	μA
					9	
I_{OS}	Input Offset Current			0.05	3	μA
V_{CM}	Input Common-Mode Range	CMRR > 60dB	-7.25		+7.25	V
CMRR	Common-Mode Rejection Ratio	$-6.5V < V_{CM} < +6.5V$	70	98		dB
			60			
A_{VOL}	Large-Signal Voltage Gain	$R_L = 2k\Omega$, $V_{OUT} = \pm 6V$	60	73		dB
V_{OUT}	Maximum Output Voltage Swing	Positive, $R_L = 2k\Omega$	+7.2	7.4		V
			+6.8			
		Negative, $R_L = 2k\Omega$		-7.4	-7.2	
					-6.8	
GBW	Gain Bandwidth Product	$R_L = 1k\Omega$		135		MHz
SR	Slew Rate			270		V/ μs
	Crosstalk	$f = 1MHz$		82		dB
I_{GND}	Short-Circuit Output Current	Source		90		mA
		Sink		32		
	Supply Current per Op Amp			2.5	3.7	
					4.3	

Test Circuit

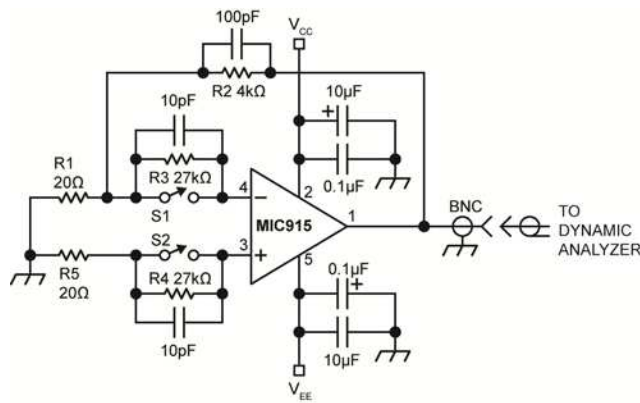


PSRR vs. Frequency



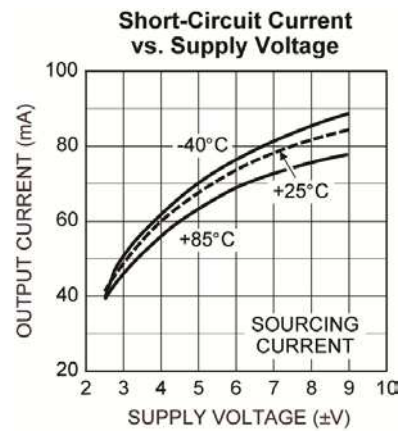
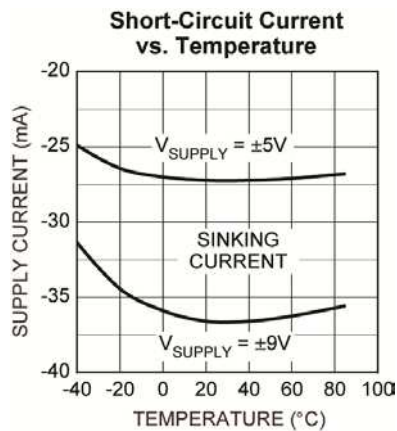
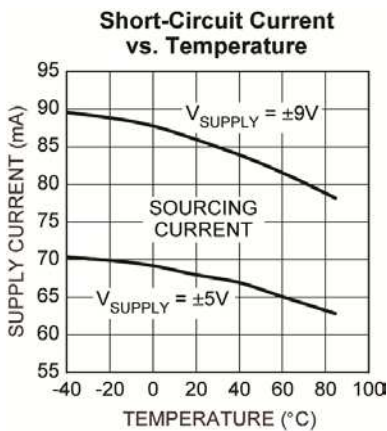
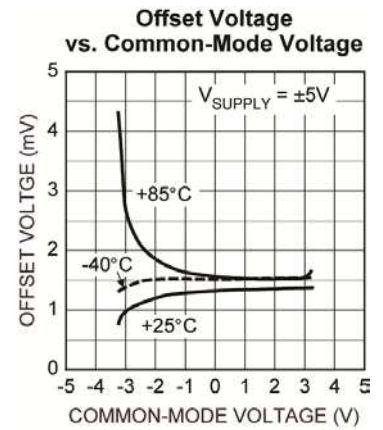
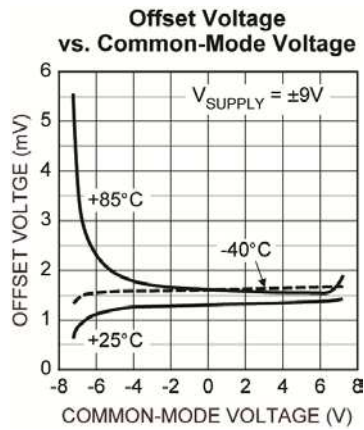
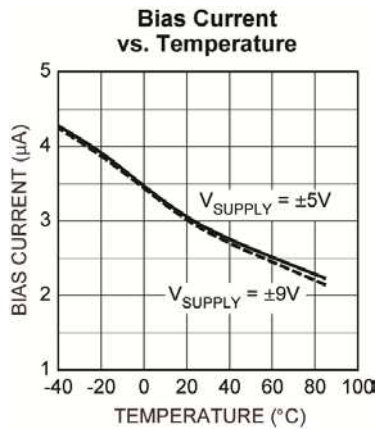
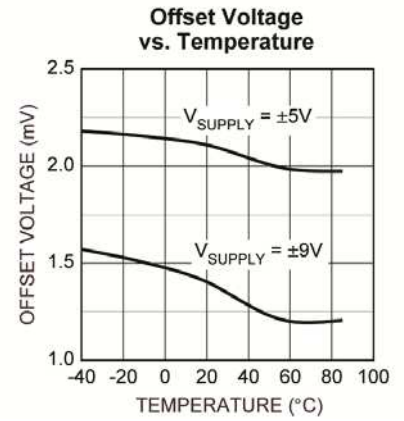
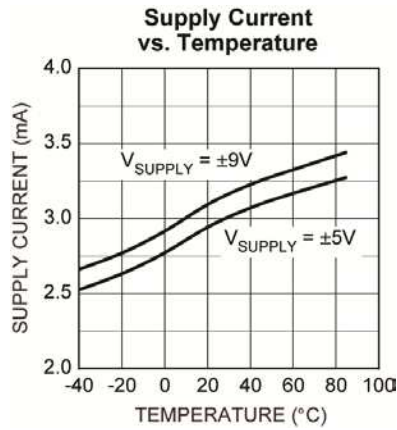
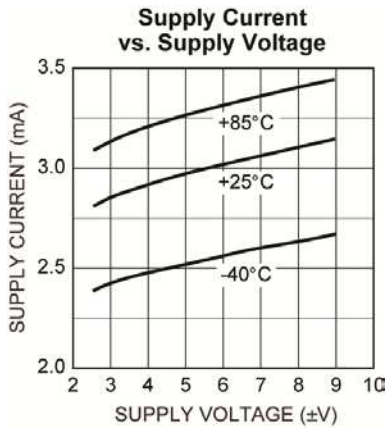
$$V_{OUT} = V_{ERROR} \left(1 + \frac{R2}{R1} + \frac{R2 + R5 + R4}{R7} \right)$$

CMRR vs. Frequency

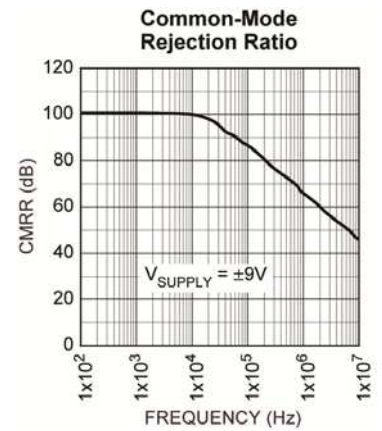
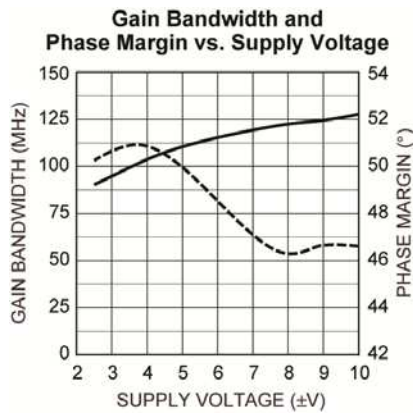
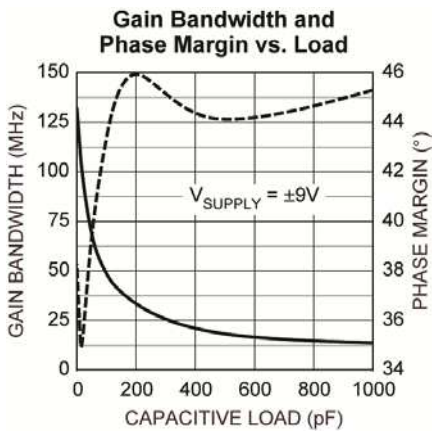
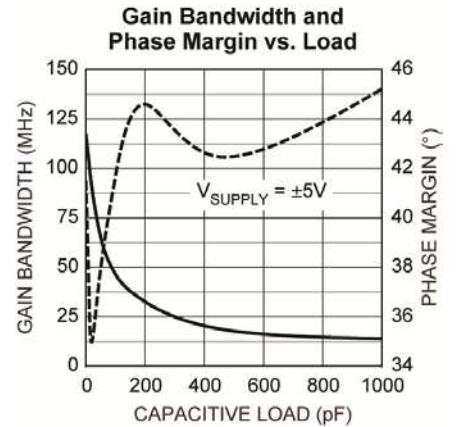
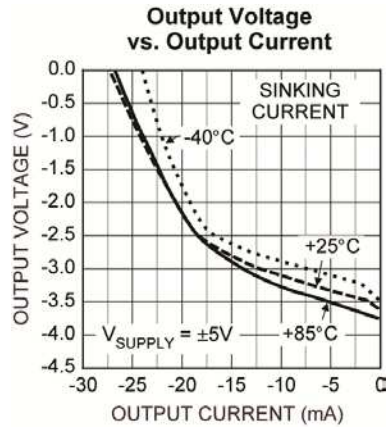
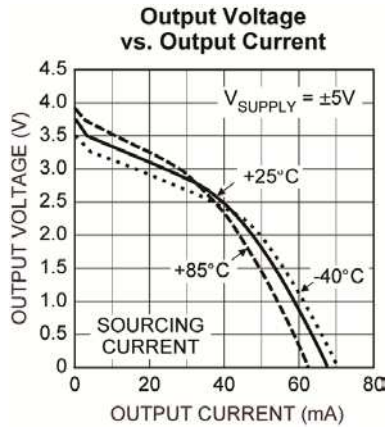
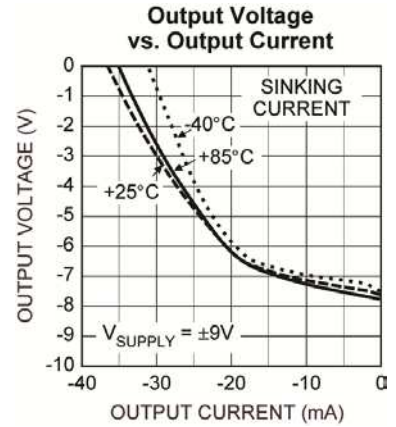
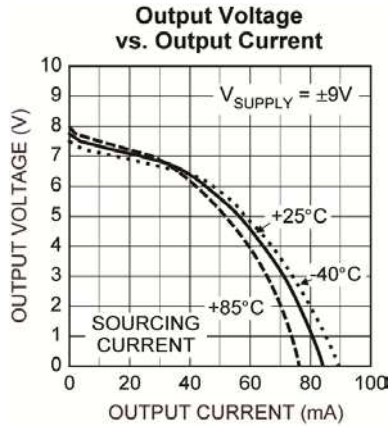
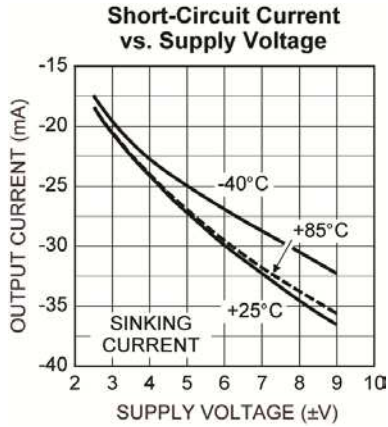


Noise Measurement

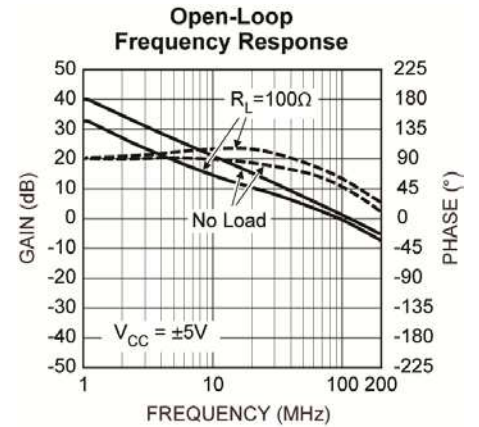
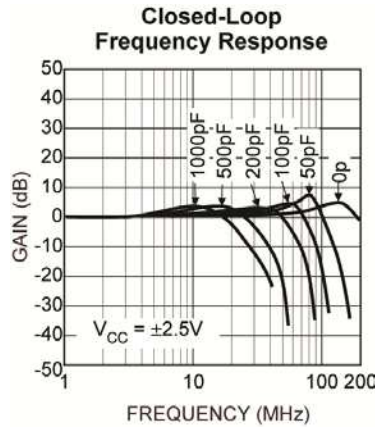
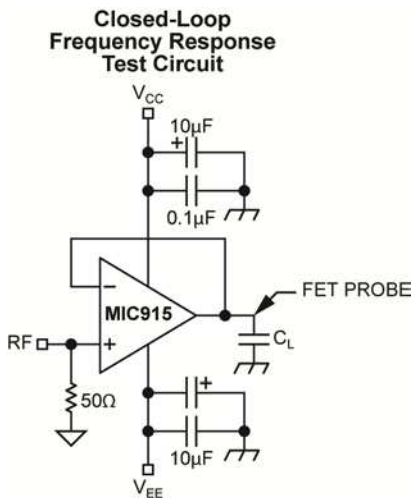
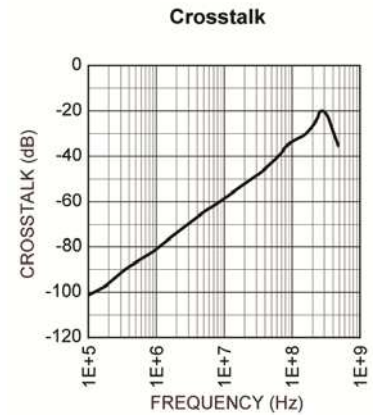
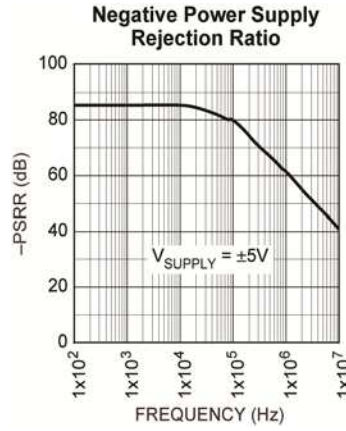
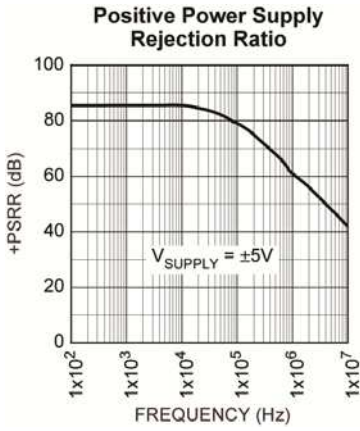
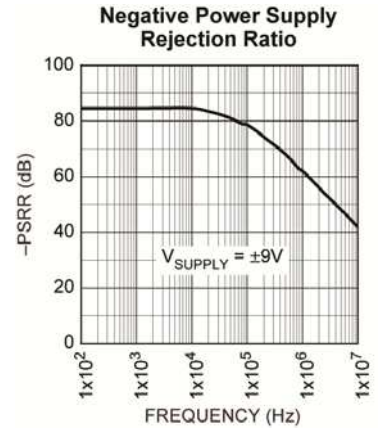
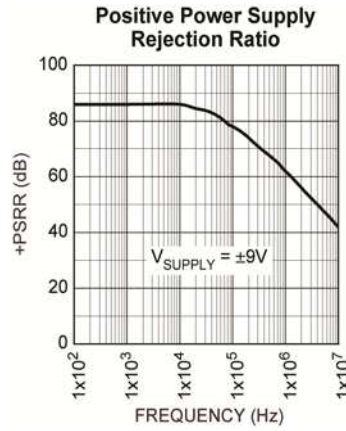
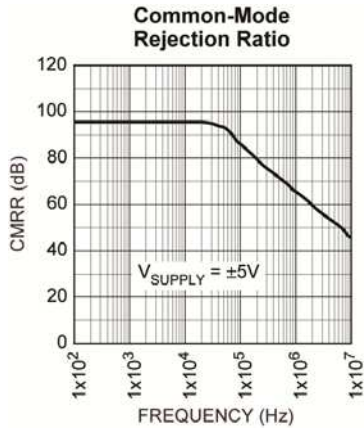
Typical Characteristics



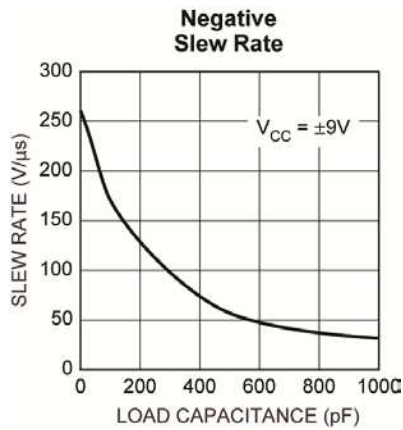
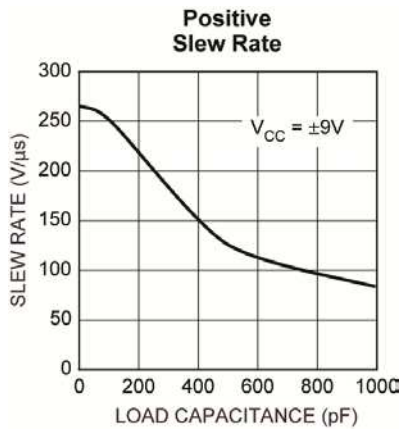
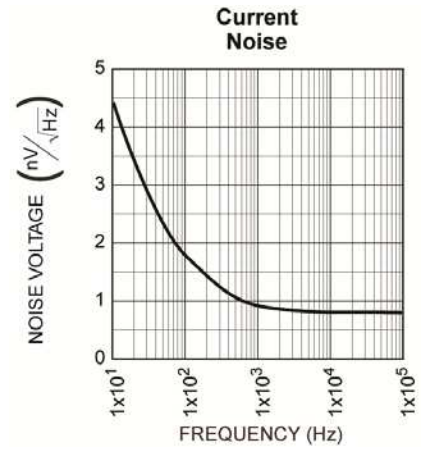
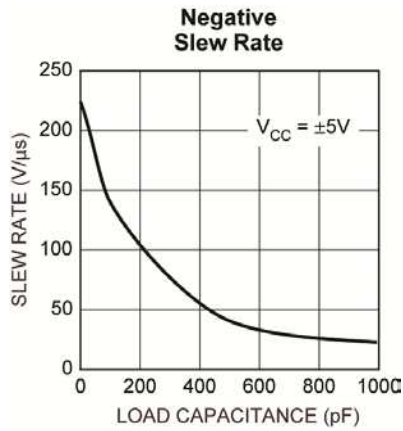
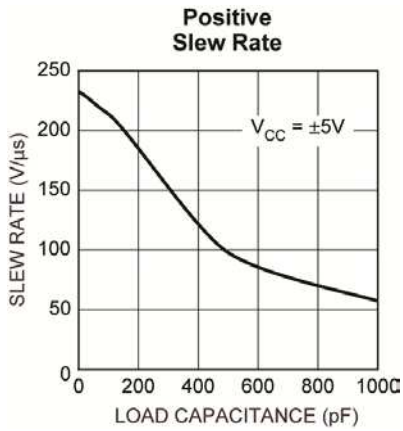
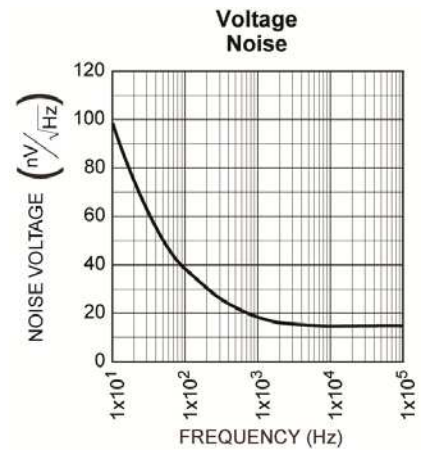
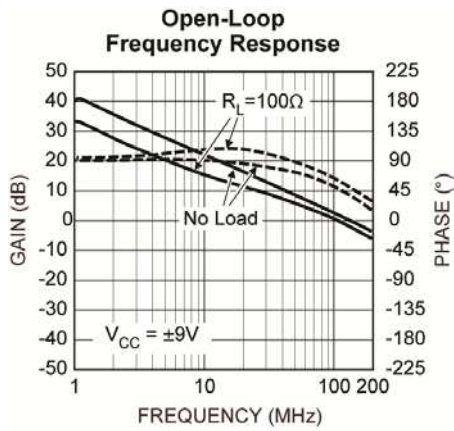
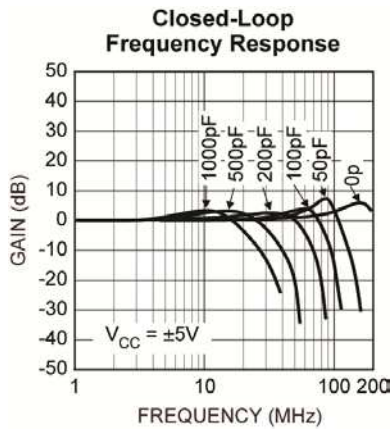
Typical Characteristics (Continued)



Typical Characteristics (Continued)

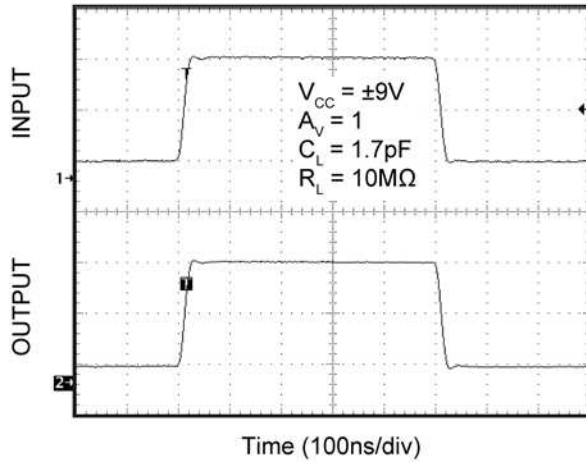


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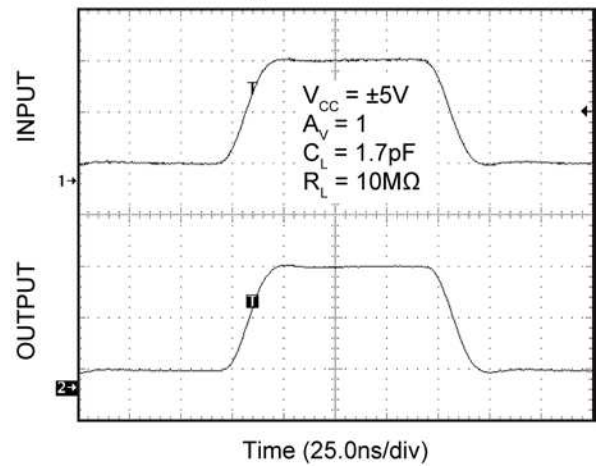


Functional Characteristics

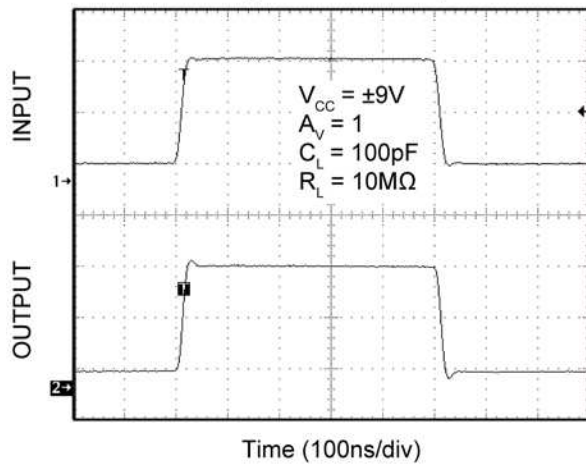
Small Signal Pulse Response



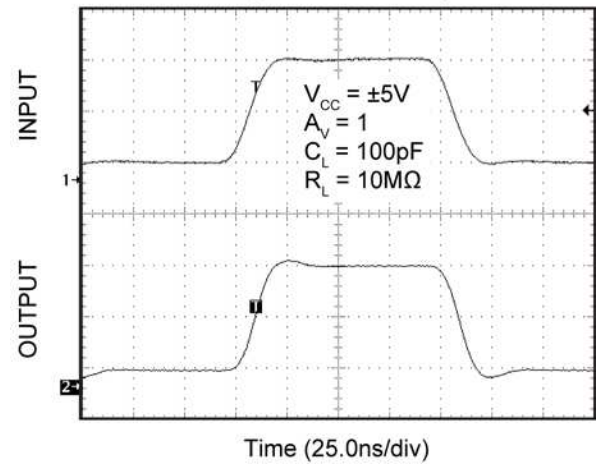
Small Signal Pulse Response



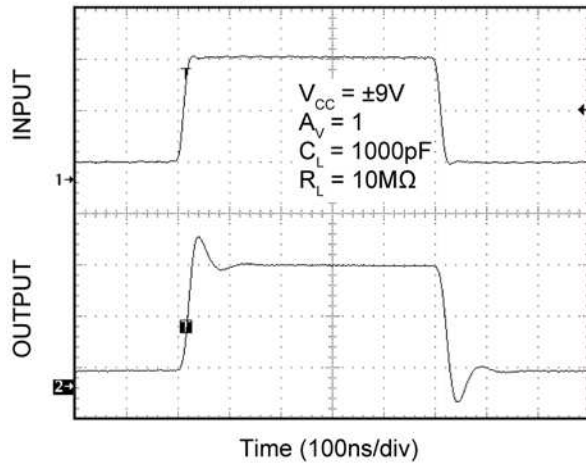
Small Signal Pulse Response



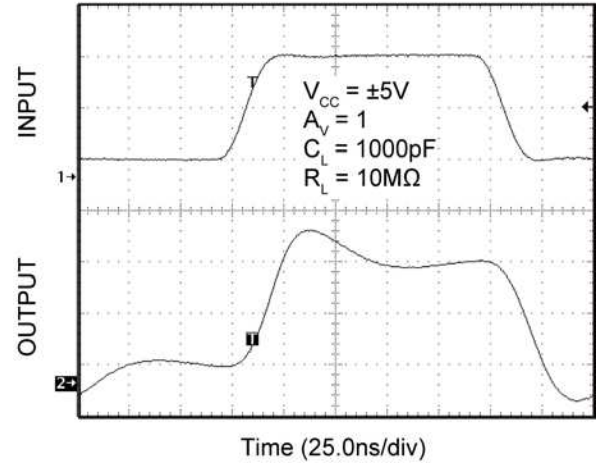
Small Signal Pulse Response



Small Signal Pulse Response

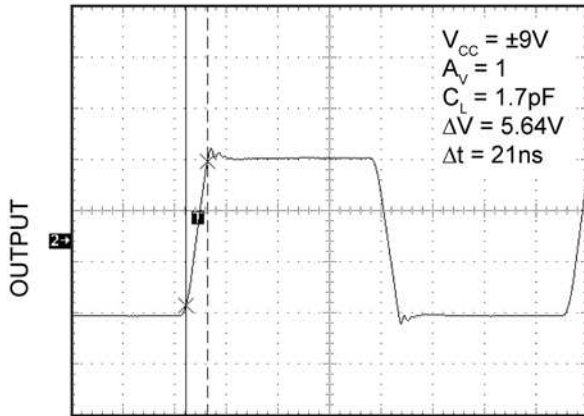


Small Signal Pulse Response



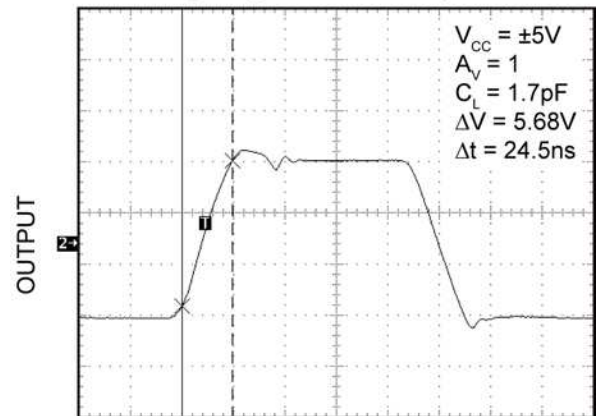
Functional Characteristics (Continued)

Large Signal Pulse Response



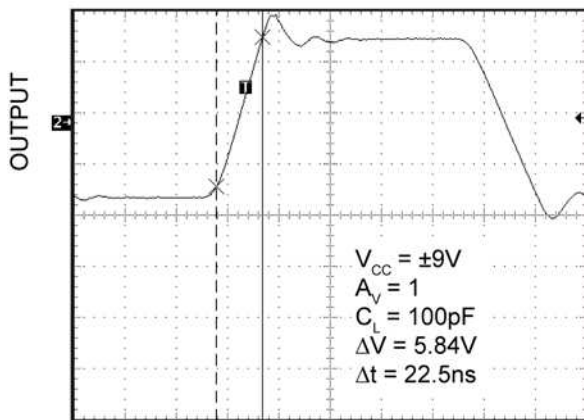
Time (50.0ns/div)

Large Signal Pulse Response



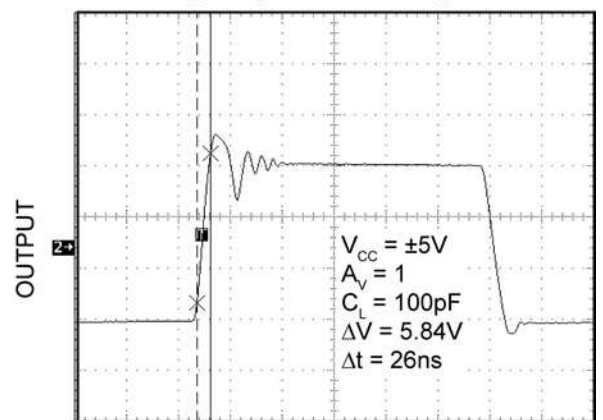
Time (25.0ns/div)

Large Signal Pulse Response



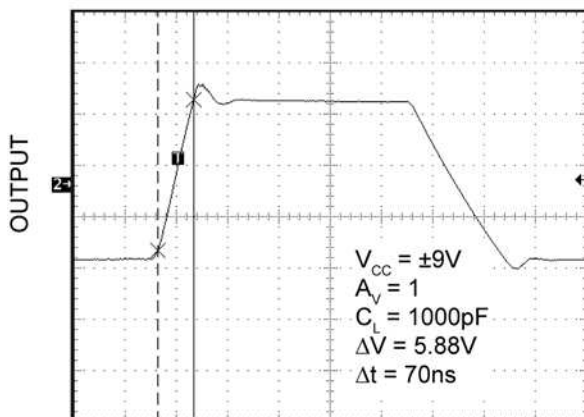
Time (25.0ns/div)

Large Signal Pulse Response



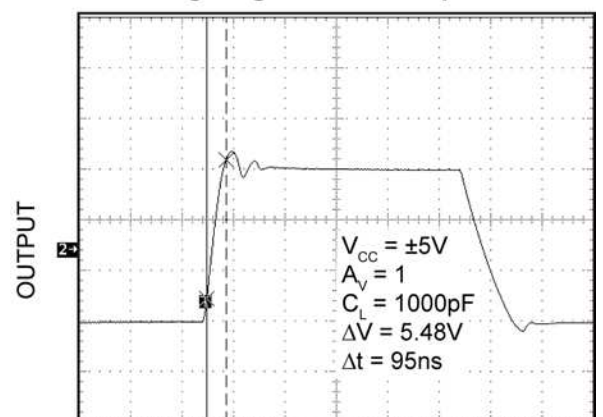
Time (100ns/div)

Large Signal Pulse Response



Time (100ns/div)

Large Signal Pulse Response



Time (250ns/div)

Application Information

The MIC915 is a high-speed, voltage-feedback operational amplifier featuring very low supply current and excellent stability. This device is unity gain stable and capable of driving high capacitance loads.

Driving High Capacitance

The MIC915 is stable when driving any capacitance (see the “Gain Bandwidth and Phase Margin vs. Load Capacitance” graph in the Typical Operating Characteristics section) making it ideal for driving long coaxial cables or other high-capacitance loads.

Phase margin remains constant as load capacitance is increased. Most high-speed op amps are only able to drive limited capacitance.

Note: Increasing load capacitance does reduce the speed of the device (see the “Gain Bandwidth and Phase Margin vs. Load” in the Typical Operating Characteristics section). In applications where the load capacitance reduces the speed of the op amp to an unacceptable level, the effect of the load capacitance can be reduced by adding a small resistor (<100Ω) in series with the output.

Feedback Resistor Selection

Conventional op amp gain configurations and resistor selection apply; the MIC915 is not a current feedback device. Resistor values in the range of 1kΩ to 10kΩ are recommended.

Layout Considerations

All high-speed devices require careful PCB layout. The high stability and high PSRR of the MIC915 make it easier to use than most other op amps, but the following guidelines should be observed:

- Capacitance, particularly on the two inputs pins will degrade performance.
- Avoid large copper traces to the inputs.
- Keep the output signal away from the inputs and use a ground plane.

It is important to ensure adequate supply bypassing capacitors are located close to the device

Power Supply Bypassing

Regular supply bypassing techniques are recommended. A 10μF capacitor in parallel with a 0.1μF capacitor on both the positive and negative supplies is ideal. For best performance, all bypassing capacitors should be located as close to the op amp as possible and all capacitors should be low equivalent series inductance (ESL) and equivalent series resistance (ESR). Surface-mount ceramic capacitors are ideal.

Note: Both V– pins must be externally shorted together.

Thermal Considerations

It is important to ensure the IC does not exceed the maximum operating junction (die) temperature of +85°C. The part can be operated up to the absolute maximum temperature rating of +125°C, but between +85°C and +125°C performance will degrade, in particular CMRR will reduce.

A MIC915 with no load, dissipates power equal to the quiescent supply current × the supply voltage (Equation 1):

$$P_{D(\text{NO LOAD})} = (V_{V+} - V_{V-})I_S \quad \text{Eq. 1}$$

When a load is added, the additional power is dissipated in the output stage of the op amp. The power dissipated in the device is a function of supply voltage, output voltage and output current (Equation 2).

$$P_{D(\text{OUTPUT STAGE})} = (V_{V+} - V_{\text{OUT}})I_{\text{OUT}} \quad \text{Eq. 2}$$

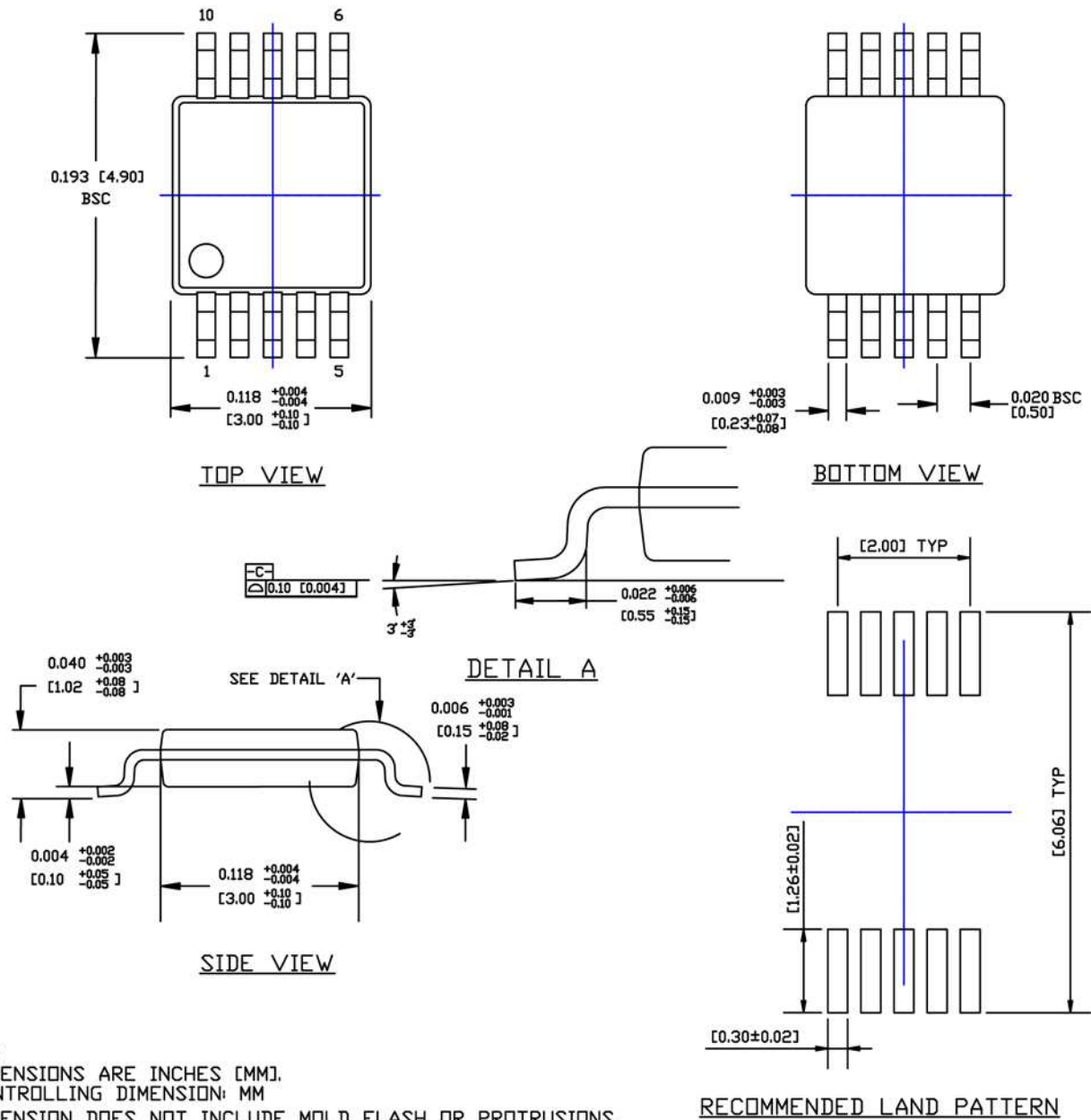
$$\text{Total Power Dissipation} = P_{D(\text{NO LOAD})} + P_{D(\text{OUTPUT STAGE})}$$

Ensure the total power dissipated in the device is no greater than the thermal capacity of the package. The 10-pin MSOP package has a thermal resistance of 160°C/W (Equation 3):

Maximum Allowable Power Dissipation =

$$\frac{T_{J(\text{MAX})} - T_{A(\text{MAX})}}{160^\circ\text{C/W}} \quad \text{Eq. 3}$$

Package Information and Recommended Landing Pattern⁽⁶⁾



10-Pin MSOP (MM)

Note:

6. Package information is correct as of the publication date. For updates and most current information, go to www.micrel.com.

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